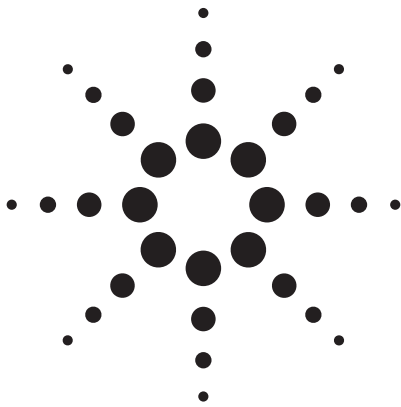




# Agilent HCPL-7723 & HCPL-0723

## 50 MBd 2 ns PWD

## High Speed CMOS Optocoupler

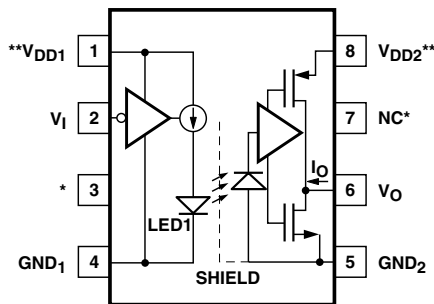
## Data Sheet

### Description

Available in either 8-pin DIP or SO-8 package style respectively, the HCPL-7723 or HCPL-0723 optocoupler utilize the latest CMOS IC technology to achieve outstanding speed performance of minimum 50 MBd data rate and 2 ns maximum pulse width distortion.

Basic building blocks of HCPL-7723/0723 are a CMOS LED driver IC, a high speed LED and a CMOS detector IC. A CMOS logic input signal controls the LED driver IC, which supplies current to the LED. The detector IC incorporates an integrated photodiode, a high speed transimpedance amplifier, and a voltage comparator with an output driver.

### Functional Diagram



\* PIN 3 IS THE ANODE OF THE INTERNAL LED AND MUST BE LEFT UNCONNECTED FOR GUARANTEED DATASHEET PERFORMANCE. PIN 7 IS NOT CONNECTED INTERNALLY.

\*\* A 0.1  $\mu$ F BYPASS CAPACITOR MUST BE CONNECTED BETWEEN PINS 1 AND 4, AND 5 AND 8.

TRUTH TABLE  
(POSITIVE LOGIC)

| V <sub>I</sub> , INPUT | LED1 | V <sub>O</sub> , OUTPUT |
|------------------------|------|-------------------------|
| H                      | OFF  | H                       |
| L                      | ON   | L                       |

### Features

- +5 V CMOS compatibility
- High speed: 50 MBd min.
- 2 ns max. pulse width distortion
- 22 ns max. prop. delay
- 16 ns max. prop. delay skew
- 10 kV/ $\mu$ s min. common mode rejection
- -40 to 85°C temperature range
- Safety and regulatory approvals (Pending)  
UL recognized  
– 3750 V rms for 1 min. per UL1577  
CSA component acceptance notice #5  
IEC/EN/DIN EN 60747-5-2  
– V<sub>orm</sub> = 630 V<sub>peak</sub> for HCPL-7723 option 060  
– V<sub>orm</sub> = 560 V<sub>peak</sub> for HCPL-0723 option 060

### Applications

- Digital fieldbus isolation: CC-Link, DeviceNet, Profibus, SDS  
Isolated A/D or D/A conversion
- Multiplexed data transmission
- High Speed Digital Input/Output
- Computer peripheral interface
- Microprocessor system interface

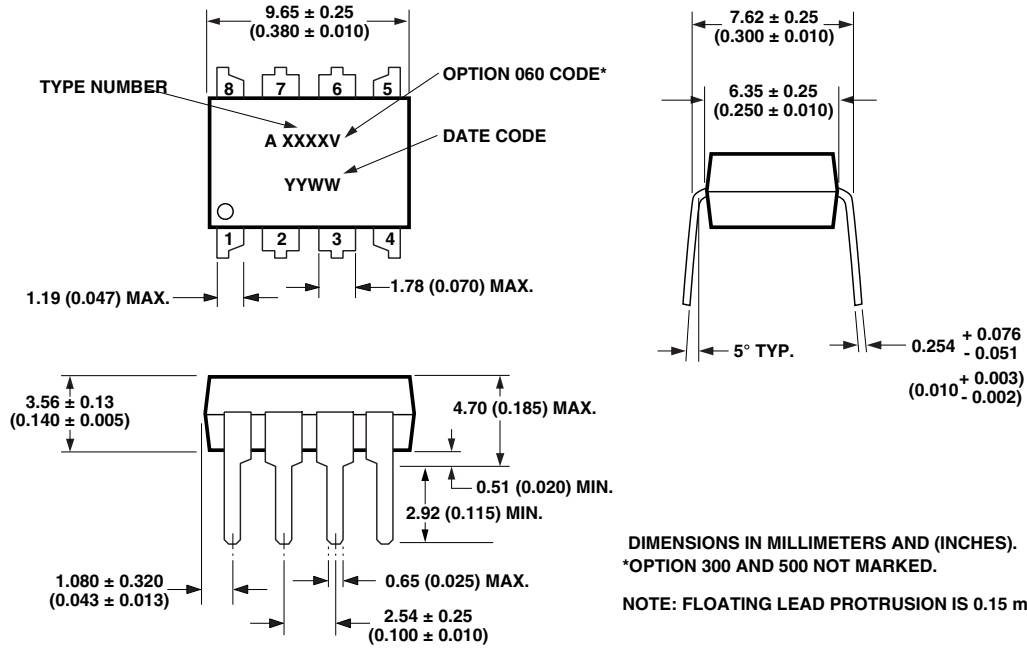
**CAUTION:** It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation, which may be induced by ESD.



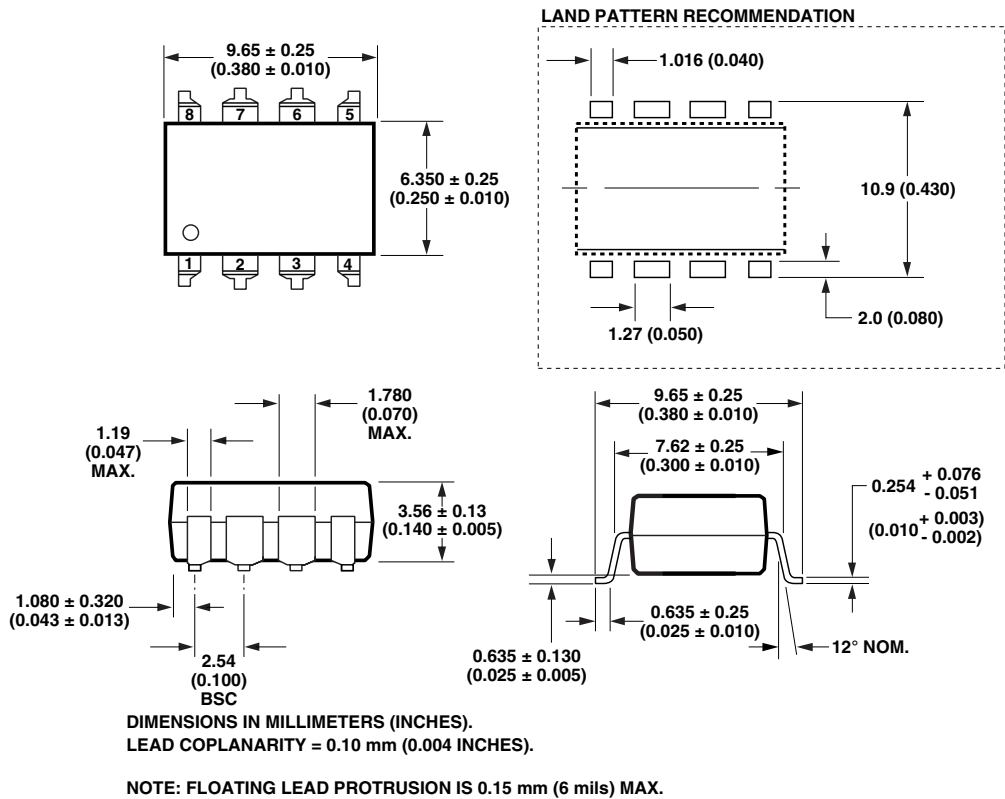
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## Package Outline Drawings

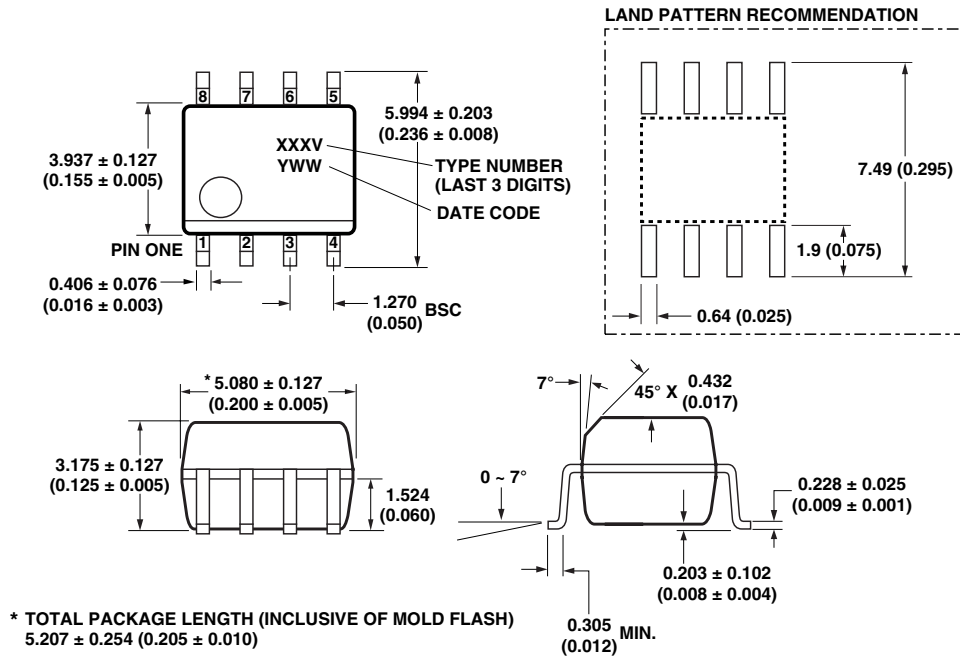
### HCPL-7723 8-Pin DIP Package



## HCPL-7723 Package with Gull Wing Surface Mount Option 300



## HCPL-0723 Small Outline SO-8 Package



## Device Selection Guide

| 8-Pin DIP (300 mil) | Small Outline SO-8 |
|---------------------|--------------------|
| HCPL-7723           | HCPL-0723          |

## Ordering Information

Specify Part Number followed by Option Number (if desired)

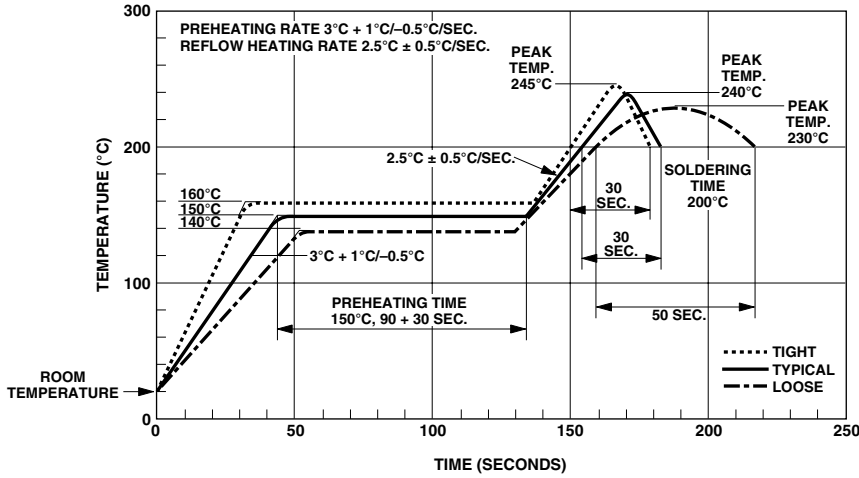
Example:

HCPL-7723-XXXX

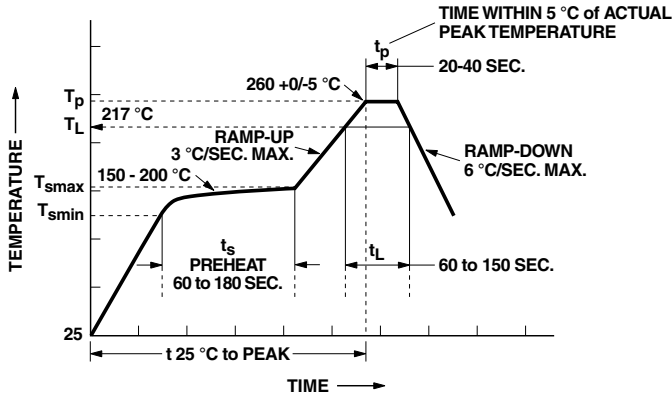
- \_\_\_\_\_ 060 = IEC/EN/DIN EN 60747-5-2 Option.
- \_\_\_\_\_ 300 = Gull Wing Surface Mount Option (HCPL-7723 only).
- \_\_\_\_\_ 500 = Tape and Reel Packaging Option.
- \_\_\_\_\_ XXXE = Lead Free Option.

No Option and Option 300 contain 50 units (HCPL-7723), 100 units (HCPL-0723) per tube. Option 500 contain 1000 units (HCPL-7723), 1500 units (HCPL-0723) per reel. Option data sheets available. Contact sales representative or authorized distributor.

## Solder Reflow Temperature Profile



## Recommended Pb-Free IR Profile



NOTES:  
THE TIME FROM  $25^{\circ}\text{C}$  TO PEAK TEMPERATURE = 8 MINUTES MAX.  
 $T_{smax} = 200^{\circ}\text{C}$ ,  $T_{smin} = 150^{\circ}\text{C}$

## Regulatory Information

The HCPL-7723/0723 have been approved by the following organizations:

### UL

Recognized under UL1577, component recognition program, File E55361.

### CSA

Approved under CSA Component Acceptance Notice #5, File CA88324.

## IEC/EN/DIN EN 60747-5-2

Approved under:

IEC 60747-5-2:1997+A1:2002/  
EN 60747-5-2:2001+A1:2002/  
DIN EN 60747-5-2 (VDE 0884

Teil 2): 2003-01.  
(Option 060 only)

## Insulation and Safety Related Specifications

| Parameter                                         | Symbol | Value      |            | Units | Conditions                                                                                    |
|---------------------------------------------------|--------|------------|------------|-------|-----------------------------------------------------------------------------------------------|
|                                                   |        | 7723       | 0723       |       |                                                                                               |
| Minimum External Air Gap (Clearance)              | L(I01) | 7.1        | 4.9        | mm    | Measured from input terminals to output terminals, shortest distance through air.             |
| Minimum External Tracking (Creepage)              | L(I02) | 7.4        | 4.8        | mm    | Measured from input terminals to output terminals, shortest distance path along body.         |
| Minimum Internal Plastic Gap (Internal Clearance) |        | 0.08       | 0.08       | mm    | Insulation thickness between emitter and detector; also known as distance through insulation. |
| Tracking Resistance (Comparative Tracking Index)  | CTI    | $\geq 175$ | $\geq 175$ | Volts | DIN IEC 112/VDE 0303 Part 1                                                                   |
| Isolation Group                                   |        | IIIa       | IIIa       |       | Material Group (DIN VDE 0110, 1/89, Table 1)                                                  |

All Agilent data sheets report the creepage and clearance inherent to the optocoupler component itself. These dimensions are needed as a starting point for the equipment designer when determining the circuit insulation requirements. However, once mounted on a printed circuit

board, minimum creepage and clearance requirements must be met as specified for individual equipment standards. For creepage, the shortest distance path along the surface of a printed circuit board between the solder fillets of the input and output leads must be considered.

There are recommended techniques such as grooves and ribs, which may be used on a printed circuit board to achieve desired creepage and clearances. Creepage and clearance distances will also change depending on factors such as pollution degree and insulation level.

#### IEC/EN/DIN EN 60747-5-2 Insulation Related Characteristics (Option 060)

| Description                                                                                                                                                                                    | Symbol         | HCPL-7723<br>Option 060 | HCPL-0723<br>Option 060 | Units              |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|-------------------------|-------------------------|--------------------|
| Installation classification per DIN VDE 0110/1.89, Table 1<br>for rated mains voltage $\leq 150$ V rms<br>for rated mains voltage $\leq 300$ V rms<br>for rated mains voltage $\leq 450$ V rms |                | I-IV<br>I-IV<br>I-III   | I-IV<br>I-III           |                    |
| Climatic Classification                                                                                                                                                                        |                | 55/85/21                | 55/85/21                |                    |
| Pollution Degree (DIN VDE 0110/1.89)                                                                                                                                                           |                | 2                       | 2                       |                    |
| Maximum Working Insulation Voltage                                                                                                                                                             | $V_{IORM}$     | 630                     | 560                     | V peak             |
| Input to Output Test Voltage, Method b*<br>$V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test with $t_m = 1$ sec,<br>Partial Discharge $< 5$ pC                                           | $V_{PR}$       | 1181                    | 1050                    | V peak             |
| Input to Output Test Voltage, Method a*<br>$V_{IORM} \times 1.5 = V_{PR}$ , Type and Sample Test, $t_m = 60$ sec,<br>Partial Discharge $< 5$ pC                                                | $V_{PR}$       | 945                     | 840                     | V peak             |
| Highest Allowable Overvoltage*<br>(Transient Overvoltage, $t_{ini} = 10$ sec)                                                                                                                  | $V_{IOTM}$     | 6000                    | 4000                    | V peak             |
| Safety Limiting Values (maximum values allowed in the event of a failure, also see Thermal Derating curve, Figure 11)                                                                          |                |                         |                         |                    |
| Case Temperature                                                                                                                                                                               | $T_S$          | 175                     | 150                     | $^{\circ}\text{C}$ |
| Input Current                                                                                                                                                                                  | $I_{S,INPUT}$  | 230                     | 150                     | mA                 |
| Output Power                                                                                                                                                                                   | $P_{S,OUTPUT}$ | 600                     | 600                     | mW                 |
| Insulation Resistance at $T_S$ , $V_{IO} = 500$ V                                                                                                                                              | $R_{IO}$       | $\geq 10^9$             | $\geq 10^9$             | $\Omega$           |

\*Refer to the front of the optocoupler section of the *Isolation and Control Component Designer's Catalog*, under Product Safety Regulations section IEC/EN/DIN EN 60747-5-2, for a detailed description.

**Note:** These optocouplers are suitable for "safe electrical isolation" only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.

**Note:** The surface mount classification is Class A in accordance with CECC 00802.

### Absolute Maximum Ratings

| Parameter                                    | Symbol                                        | Min. | Max.            | Units |
|----------------------------------------------|-----------------------------------------------|------|-----------------|-------|
| Storage Temperature                          | $T_S$                                         | –55  | 125             | °C    |
| Ambient Operating Temperature <sup>[1]</sup> | $T_A$                                         | –40  | 85              | °C    |
| Supply Voltages                              | $V_{DD1}, V_{DD2}$                            | 0    | 6.0             | Volts |
| Input Voltage                                | $V_I$                                         | –0.5 | $V_{DD1} + 0.5$ | Volts |
| Output Voltage                               | $V_O$                                         | –0.5 | $V_{DD2} + 0.5$ | Volts |
| Average Output Current                       | $I_O$                                         |      | 10              | mA    |
| Lead Solder Temperature                      | 260°C for 10 sec., 1.6 mm below seating plane |      |                 |       |
| Solder Reflow Temperature Profile            | See Solder Reflow Temperature Profile Section |      |                 |       |

### Recommended Operating Conditions

| Parameter                        | Symbol             | Min. | Max.      | Units |
|----------------------------------|--------------------|------|-----------|-------|
| Ambient Operating Temperature    | $T_A$              | –40  | 85        | °C    |
| Supply Voltages                  | $V_{DD1}, V_{DD2}$ | 4.5  | 5.5       | V     |
| Logic High Input Voltage         | $V_{IH}$           | 2.0  | $V_{DD1}$ | V     |
| Logic Low Input Voltage          | $V_{IL}$           | 0.0  | 0.8       | V     |
| Input Signal Rise and Fall Times | $t_r, t_f$         |      | 1.0       | ms    |

### Electrical Specifications

Test conditions that are not specified can be anywhere within the recommended operating range.

All typical specifications are at  $T_A = +25^\circ\text{C}$ ,  $V_{DD1} = V_{DD2} = +5\text{ V}$ .

| Parameter                                      | Symbol     | Min. | Typ. | Max. | Units | Test Conditions                        |
|------------------------------------------------|------------|------|------|------|-------|----------------------------------------|
| Logic Low Input Supply Current <sup>[2]</sup>  | $I_{DD1L}$ |      | 7    | 10   | mA    | $V_I = 0\text{ V}$                     |
| Logic High Input Supply Current <sup>[2]</sup> | $I_{DD1H}$ |      | 1.8  | 3    | mA    | $V_I = V_{DD1}$                        |
| Output Supply Current                          | $I_{DD2L}$ |      | 12.5 | 17.5 | mA    |                                        |
|                                                | $I_{DD2H}$ |      | 12   | 16.5 | mA    |                                        |
| Input Current                                  | $I_I$      | –10  |      | 10   | μA    |                                        |
| Logic High Output Voltage                      | $V_{OH}$   | 4.4  | 5.0  |      | V     | $I_O = -20\text{ μA}$ , $V_I = V_{IH}$ |
|                                                |            | 4.0  | 4.8  |      | V     | $I_O = -4\text{ mA}$ , $V_I = V_{IH}$  |
| Logic Low Output Voltage                       | $V_{OL}$   |      | 0    | 0.1  | V     | $I_O = 20\text{ μA}$ , $V_I = V_{IL}$  |
|                                                |            |      | 0.5  | 1.0  | V     | $I_O = 4\text{ mA}$ , $V_I = V_{IL}$   |

## Switching Specifications

Test conditions that are not specified can be anywhere within the recommended operating range.

All typical specifications are at  $T_A = +25^\circ\text{C}$ ,  $V_{DD1} = V_{DD2} = +5\text{ V}$ .

| Parameter                                                          | Symbol             | Min. | Typ. | Max. | Units             | Test Conditions                                                                                    |
|--------------------------------------------------------------------|--------------------|------|------|------|-------------------|----------------------------------------------------------------------------------------------------|
| Propagation Delay Time to Logic Low Output <sup>[3]</sup>          | $t_{PHL}$          |      | 16   | 22   | ns                | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Propagation Delay Time to Logic High Output <sup>[3]</sup>         | $t_{PLH}$          |      | 16   | 22   | ns                | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Pulse Width                                                        | PW                 | 20   |      |      | ns                | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Maximum Data Rate                                                  |                    | 50   |      |      | MBd               | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Pulse Width Distortion <sup>[4]</sup> $ t_{PHL} - t_{PLH} $        | IPWDI              |      | 1    | 2    | ns                | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Propagation Delay Skew <sup>[5]</sup>                              | $t_{PSK}$          |      |      | 16   | ns                | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Output Rise Time (10% – 90%)                                       | $t_R$              |      | 8    |      | ns                | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Output Fall Time (90% - 10%)                                       | $t_F$              |      | 6    |      | ns                | $C_L = 15\text{ pF}$ CMOS Signal Levels                                                            |
| Common Mode Transient Immunity at Logic High Output <sup>[6]</sup> | ICM <sub>H</sub> I | 10   | 15   |      | kV/ $\mu\text{s}$ | $V_{CM} = 1000\text{ V}$ , $T_A = 25^\circ\text{C}$ ,<br>$V_I = V_{DD1}$ , $V_O > 0.8 V_{DD2}$     |
| Common Mode Transient Immunity at Logic Low Output <sup>[6]</sup>  | ICM <sub>L</sub> I | 10   | 15   |      | kV/ $\mu\text{s}$ | $V_{CM} = 1000\text{ V}$ , $T_A = 25^\circ\text{C}$ ,<br>$V_I = 0\text{ V}$ , $V_O < 0.8\text{ V}$ |

## Package Characteristics

All Typical Specifications are at  $T_A = 25^\circ\text{C}$ .

| Parameter                                                   |                       | Symbol         | Min.                | Typ.              | Max. | Units              | Test Conditions                                                    |
|-------------------------------------------------------------|-----------------------|----------------|---------------------|-------------------|------|--------------------|--------------------------------------------------------------------|
| Input-Output Momentary Withstand Voltage <sup>[7,8,9]</sup> | $\frac{-7723}{-0723}$ | $V_{ISO}$      | $\frac{3750}{3750}$ |                   |      | V rms              | $RH \leq 50\%$ , $t = 1 \text{ min}$ ,<br>$T_A = 25^\circ\text{C}$ |
| Input-Output Resistance <sup>[7]</sup>                      |                       | $R_{I-O}$      |                     | $10^{12}$         |      | $\Omega$           | $V_{I-O} = 500 \text{ V dc}$                                       |
| Input-Output Capacitance                                    |                       | $C_{I-O}$      |                     | 0.6               |      | pF                 | $f = 1 \text{ MHz}$                                                |
| Input Capacitance <sup>[10]</sup>                           |                       | $C_I$          |                     | 3.0               |      | pF                 |                                                                    |
| Input IC Junction-to-Case Thermal Resistance                | $\frac{-7723}{-0723}$ | $\theta_{jci}$ |                     | $\frac{145}{160}$ |      | $^\circ\text{C/W}$ | Thermocouple located at center underside of package                |
| Output IC Junction-to-Case Thermal Resistance               | $\frac{-7723}{-0723}$ | $\theta_{jco}$ |                     | $\frac{145}{135}$ |      | $^\circ\text{C/W}$ |                                                                    |
| Package Power Dissipation                                   |                       | $P_{PD}$       |                     |                   | 150  | mW                 |                                                                    |

### Notes:

1. Absolute Maximum ambient operating temperature means the device will not be damaged if operated under these conditions. It does not guarantee functionality.
2. The LED is ON when VI is low and OFF when VI is high.
3. tPHL propagation delay is measured from the 50% level on the falling edge of the VI signal to the 50% level of the falling edge of the VO signal. tPLH propagation delay is measured from the 50% level on the rising edge of the VI signal to the 50% level of the rising edge of the VO signal.
4. PWD is defined as  $t_{PHL} - t_{PLH}$ . %PWD (percent pulse width distortion) is equal to the PWD divided by pulse width.
5. tPSK is equal to the magnitude of the worst case difference in tPHL and/or tPLH that will be seen between units at any given temperature within the recommended operating conditions.
6. CMH is the maximum common mode voltage slew rate that can be sustained while maintaining  $VO > 0.8 V_{DD2}$ . CML is the maximum common mode voltage slew rate that can be sustained while maintaining  $VO < 0.8 \text{ V}$ . The common mode voltage slew rates apply to both rising and falling common mode voltage edges.
7. Device considered a two-terminal device: pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together.
8. In accordance with UL1577, each HCPL-0723 is proof tested by applying an insulation test voltage  $\geq 4500 \text{ Vrms}$  for 1 second (leakage detection current limit,  $I_{I-O} \leq 5 \mu\text{A}$ ). Each HCPL-7723 is proof tested by applying an insulation test voltage  $\geq 4500 \text{ Vrms}$  for 1 second (leakage detection current limit,  $I_{I-O} \leq 5 \mu\text{A}$ ).
9. The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to your equipment level safety specification or Agilent Application Note 1074 entitled "Optocoupler Input-Output Endurance Voltage."
10. CI is the capacitance measured at pin 2 (VI).

## Application Information

### Bypassing and PC Board Layout

The HCPL-7723/0723 optocouplers are extremely easy to use. No external interface circuitry is required because the HCPL-7723/0723 use high-speed CMOS IC technology allowing CMOS logic to be connected directly to the inputs and outputs.

As shown in Figure 1, the only external components required for proper operation are two bypass capacitors. Capacitor values

should be between 0.01  $\mu\text{F}$  and 0.1  $\mu\text{F}$ . For each capacitor, the total lead length between both ends of the capacitor and the power-supply pins should not exceed 20 mm. Figure 2 illustrates the recommended printed circuit board layout for the HCPL-7723/0723.

### Propagation Delay, Pulse-Width Distortion and Propagation Delay Skew

Propagation Delay is a figure of merit which describes how quickly a logic signal propagates through

a system as illustrated in Figure 3. The propagation delay from low to high ( $t_{PLH}$ ) is the amount of time required for an input signal to propagate to the output, causing the output to change from low to high. Similarly, the propagation delay from high to low ( $t_{PHL}$ ) is the amount of time required for the input signal to propagate to the output, causing the output to change from high to low.

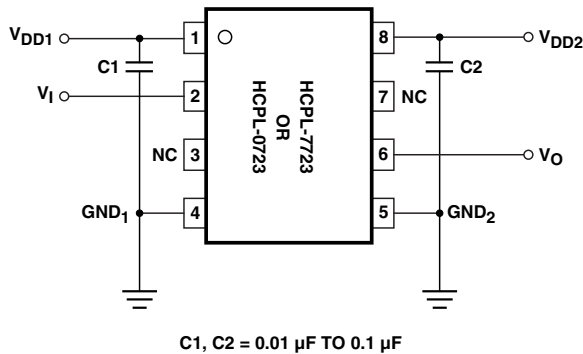


Figure 1. Functional diagram.

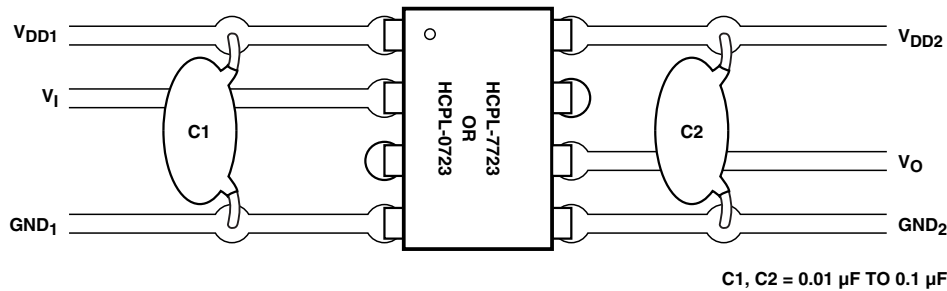


Figure 2. Recommended printed circuit board layout.

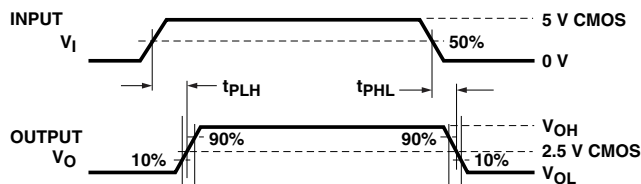


Figure 3. Timing diagram to illustrate propagation delay,  $t_{PLH}$  and  $t_{PHL}$ .

Pulse-width distortion (PWD) is the difference between  $t_{PHL}$  and  $t_{PLH}$  and often determines the maximum data rate capability of a transmission system. PWD can be expressed in percent by dividing the PWD (in ns) by the minimum pulse width (in ns) being transmitted. Typically, PWD on the order of 20-30% of the minimum pulse width is tolerable.

Propagation delay skew,  $t_{PSK}$ , is an important parameter to consider in parallel data applications where synchronization of signals on parallel data lines is a concern. If the parallel data is being sent through a group of

optocouplers, differences in propagation delays will cause the data to arrive at the outputs of the optocouplers at different times. If this difference in propagation delay is large enough it will determine the maximum rate at which parallel data can be sent through the optocouplers.

Propagation delay skew is defined as the difference between the minimum and maximum propagation delays, either  $t_{PLH}$  or  $t_{PHL}$ , for any given group of optocouplers which are operating under the same conditions (i.e., the same drive current, supply voltage, output load, and operating temperature). As

illustrated in Figure 4, if the inputs of a group of optocouplers are switched either ON or OFF at the same time,  $t_{PSK}$  is the difference between the shortest propagation delay, either  $t_{PLH}$  or  $t_{PHL}$ , and the longest propagation delay, either  $t_{PLH}$  or  $t_{PHL}$ .

As mentioned earlier,  $t_{PSK}$  can determine the maximum parallel data transmission rate. Figure 5 is the timing diagram of a typical parallel data application with both the clock and data lines being sent through the optocouplers. The figure shows data and clock signals at the inputs and outputs of the optocouplers. In this case the data is assumed to be clocked off of the rising edge of the clock.

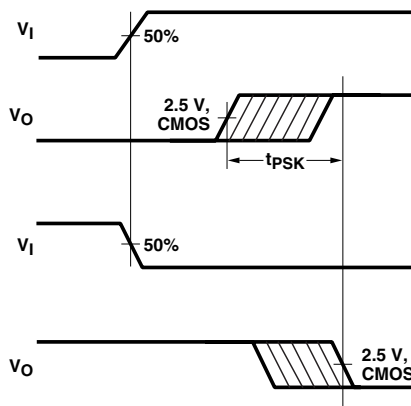


Figure 4. Timing diagram to illustrate propagation delay skew,  $t_{PSK}$ .

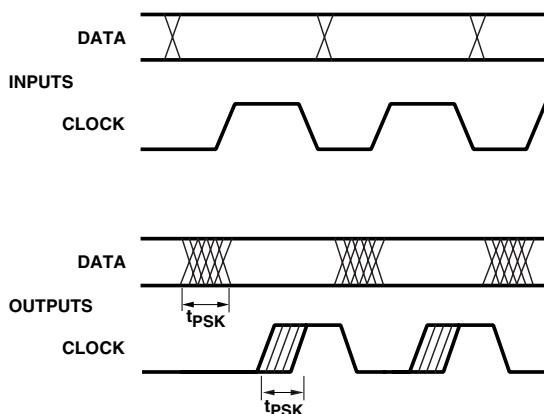


Figure 5. Parallel data transmission example.

Propagation delay skew represents the uncertainty of where an edge might be after being sent through an optocoupler. Figure 5 shows that there will be uncertainty in both the data and clock lines. It is important that these two areas of uncertainty not overlap, otherwise the clock signal might arrive before all of the data outputs have settled, or some of the data outputs may start to change before the clock signal has arrived. From these considerations, the absolute minimum pulse width that can be sent through optocouplers in a parallel application is twice  $t_{PSK}$ . A cautious design should use a slightly longer pulse width to ensure that any additional uncertainty in the rest of the circuit does not cause a problem.

The HCPL-7723/0723 optocouplers offer the advantage of guaranteed specifications for propagation delays, pulse-width distortion, and propagation delay skew over the recommended temperature and power supply ranges.

**[www.agilent.com/semiconductors](http://www.agilent.com/semiconductors)**

For product information and a complete list of distributors, please go to our web site.

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March 1, 2005

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